Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
  - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

National Semiconductor

June 1989

9316/DM9316 Synchronous 4-Bit Counters

General Description

These synchronous, presettable counters feature an internal carry look-ahead for application in high-speed counting designs. The 9316 is a 4-bit binary counter. The carry output is decoded by means of a NOR gate, thus preventing spikes during the normal counting mode of operation. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the count-enables inputs and internal gating. This mode of operating eliminates the output counting spikes which are normally associated with asynchronous (ripple clock) counters. A buffered clock input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform.

These counters are fully programmable; that is, the outputs may be preset to either level. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse regardless of the levels of the enable input. Low-to-high transitions at the load input are perfectly acceptable regardless of the logic levels on the clock or enable inputs. The clear function is asynchronous and a low level at the clear input sets of the flip-flop outputs low regardless of the levels of clock, load, or enable inputs.

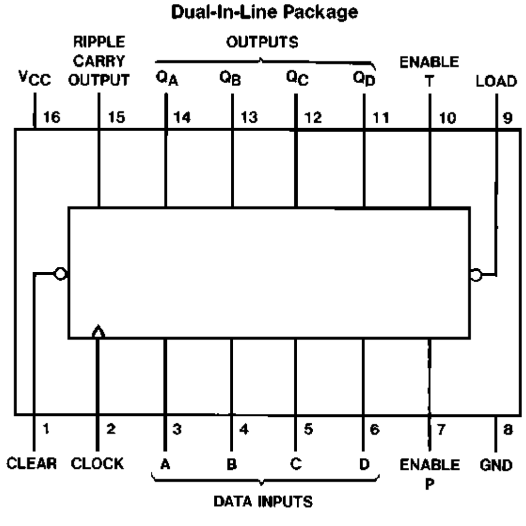
The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable inputs and a ripple carry output. Both count-enable inputs (P and T) must be high to count, and input T is fed-forward to enable the ripple carry output. The ripple carry output thus enabled will produce a high-level output pulse with a duration approximately equal to the high-level portion of the Q_A output. This high-level overflow ripple carry pulse can be used to enable successive cascaded stages. High-to-low level transitions at the enable P or T inputs may occur regardless of the logic level in the clock.

Features

- Internal look-ahead for fast counting
- Carry output for n-bit cascading
- Synchronous counting
- Load control line
- Diode-clamped inputs
- Typical clock frequency 35 MHz
- Pin-for-pin replacements popular 54/74 counters 5416A/7416A (binary)
- Alternate Military/Aerospace device (9316) is available. Contact a National Semiconductor Sales Office/Distributor for specifications.

Connection Diagram

Dual-In-Line Package



TL/F/6606–1

Order Number 9316DMQB, 9316FMQB, DM9316J DM9316W or DM9316N See NS Package Number J16A, N16E or W16A

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
Military	−55°C to +125°C
Commercial	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: *The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.*

Recommended Operating Conditions

Symbol	Parameter		Military			Commercial			Units
			Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage		2			2			V
V_{IL}	Low Level Input Voltage				0.8			0.8	V
I_{OH}	High Level Output Current				−0.8			−0.8	mA
I_{OL}	Low Level Output Current				16			16	mA
f_{CLK}	Clock Frequency (Note 6)		0		25	0		25	MHz
t_W	Pulse Width (Note 6)	Clock	25			25			ns
		Clear	20			20			
t_{SU}	Setup Time (Note 6)	Data	20			20			ns
		Enable P	20			20			
		Load	25			25			
		Clear	20			20			
t_H	Any Hold Time (Notes 1 & 6)		0			0			ns
T_A	Free Air Operating Temperature		−55		125	0		70	°C

Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min		2.4	3.4		V
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min, V_{IL} = Max			0.2	0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max V_I = 2.4 V	Clock			80	μA
			Enable T			80	
			Other			40	
I_{IL}	Low Level Input Current	V_{CC} = Max V_I = 0.4V	Clock			−3.2	μA
			Enable T			−3.2	
			Other			−1.6	
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	MIL	−20		−57	mA
			COM	−18		−57	
I_{CCH}	Supply Current with Outputs High	V_{CC} = Max (Note 4)	MIL		59	85	mA
			COM		59	94	
I_{CCL}	Supply Current with Outputs Low	V_{CC} = Max (Note 5)	MIL		63	91	mA
			COM		63	101	

Note 1: The minimum HOLD time is as specified or as long as the CLOCK input takes to rise from 0.8V to 2V, whichever is longer.

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time.

Note 4: I_{CCH} is measured with the LOAD input high, then again with the LOAD input low, with all other inputs high and all outputs open.

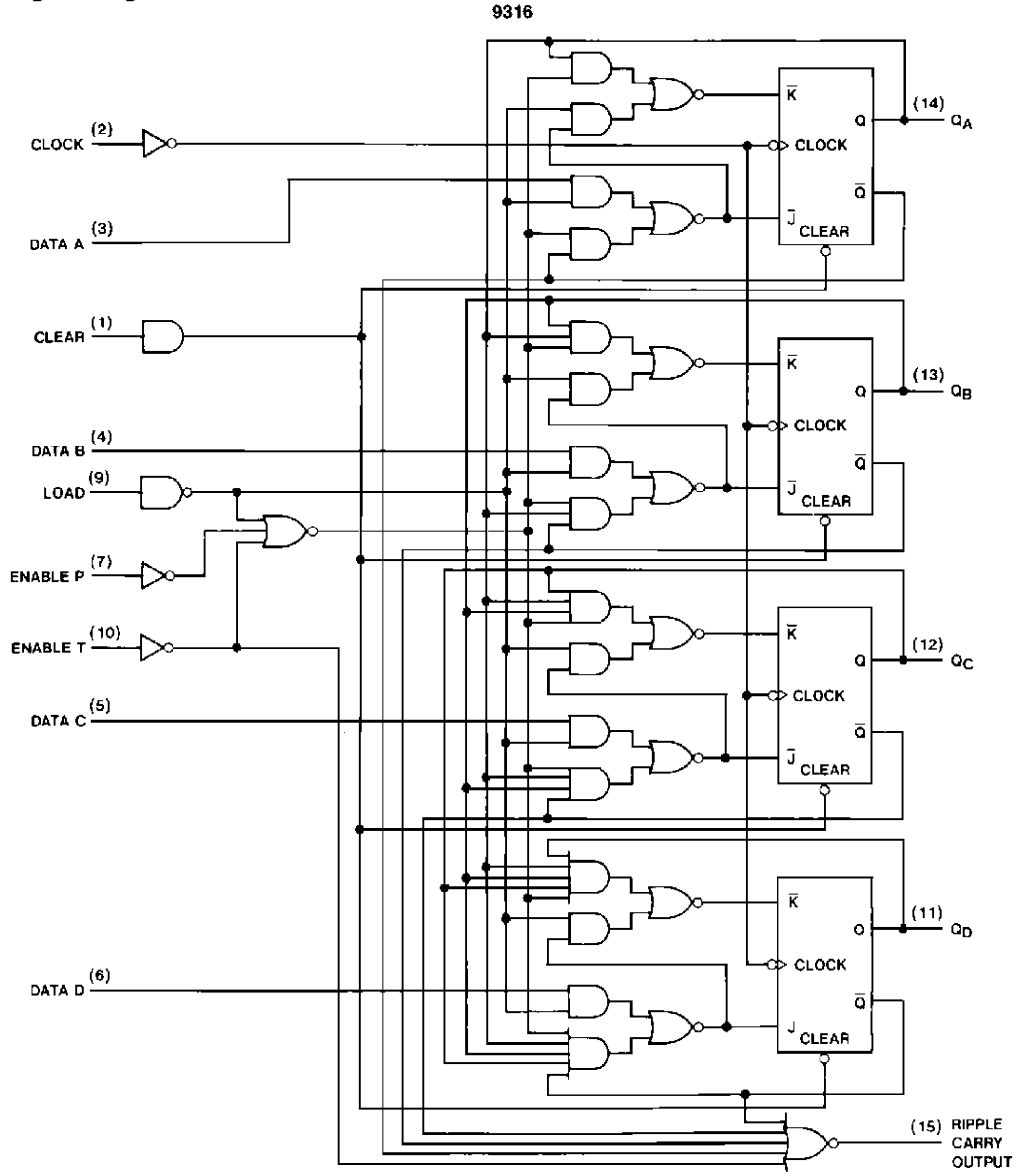
Note 5: I_{CCL} is measured with the CLOCK input high, then again with the CLOCK input low, with all other inputs low and all outputs open.

Note 6: T_A = 25°C and V_{CC} = 5V.

Switching Characteristics at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	From (Input) To (Output)	$R_L = 400\Omega$, $C_L = 15\,pF$		Units
			Min	Max	
f_{MAX}	Maximum Clock Frequency		25		MHz
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to RC		27	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to RC		24	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to Q		20	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to Q		23	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Clock to Q		21	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clock to Q		25	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	ENT to RC		15	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	ENT to RC		16	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Clear to Q		36	ns

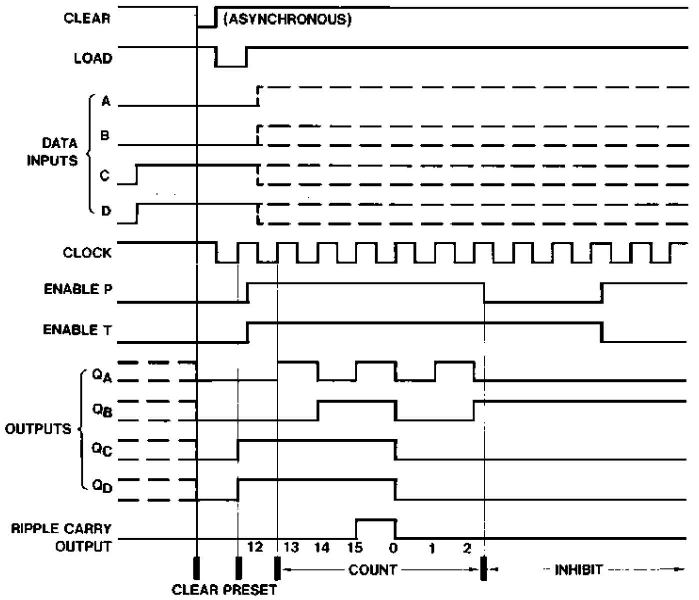
Logic Diagram



TL/F/6606-2

Timing Diagram

9316 Synchronous Binary Counters
Typical Clear, Preset, Count and Inhibit Sequences



TL/F/6606–3

Sequence:

(1) Clear outputs to zero.

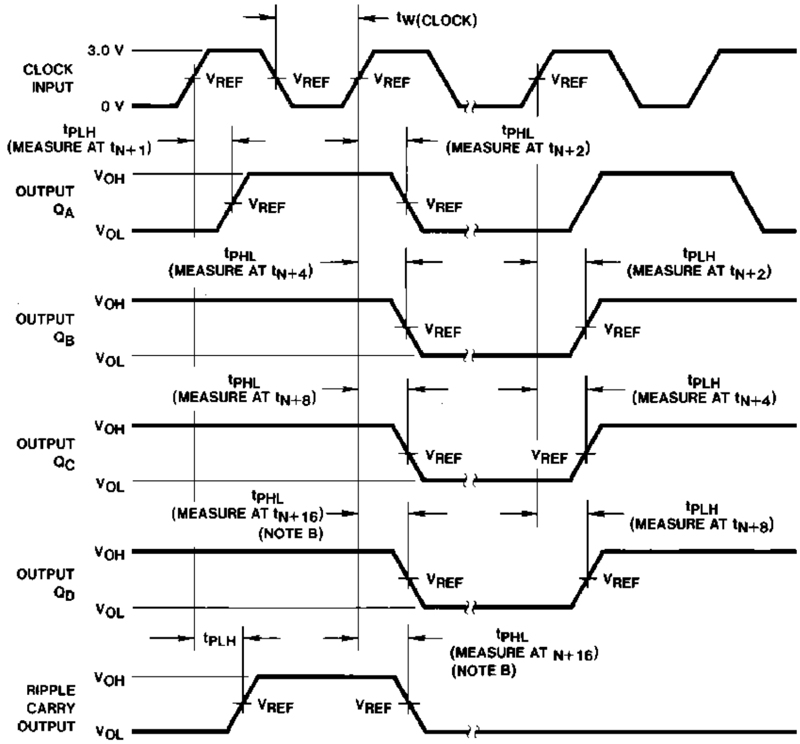
(2) Preset to binary twelve.

(3) Count to thirteen, fourteen, fifteen, zero, one, and two.

(4) Inhibit

Parameter Measurement Information

Switching Time Waveforms



TL/F/6606–4

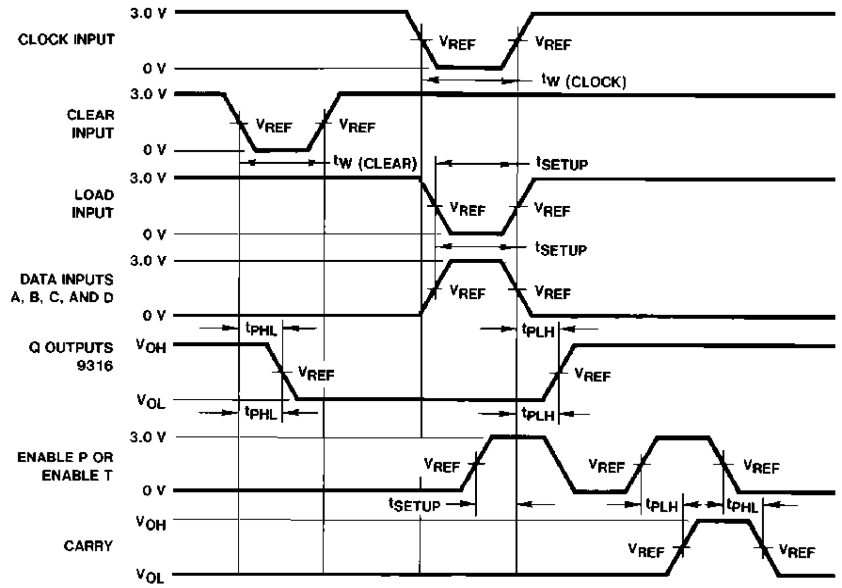
Note A: The input pulses are supplied by a generator having the following characteristics: PRR $\leq$ 1 MHz, duty cycle $\leq$ 50%, $Z_{OUT} \approx 50\Omega$, $t_r \leq 10$ ns, $t_f \leq 10$ ns. Vary PRR to measure f_{MAX}.

Note B: Outputs Q_D and carry are tested at t_{n+16} for 9316/8316, where t_n is the bit time when all outputs are low.

Note C: V_{REF} = 1.5V.

Parameter Measurement Information (Continued)

Switching Time Waveforms



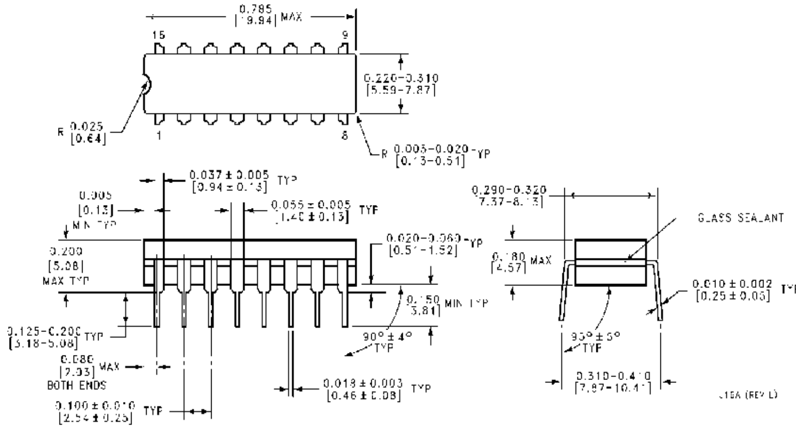
TL/F/6606–5

Note A: The input pulses are supplied by generators having the following characteristics: PRR $\leq$ 1 MHz, duty cycle $\leq$ 50%, $Z_{OUT} \approx 50\Omega$, $t_r \leq 10$ ns, $t_f \leq 10$ ns.

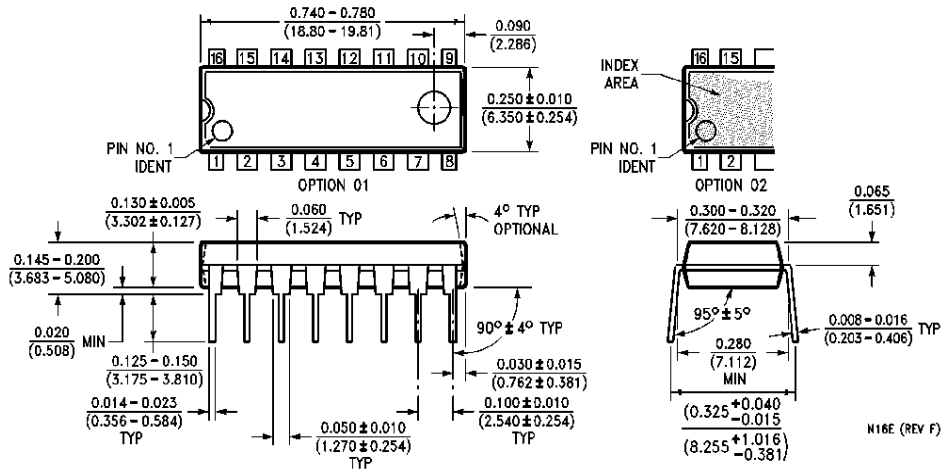
Note B: Enable P and Enable T setup times are measured at t_{n+16} for 8316/9316.

Note C: $V_{REF} = 1.5V$.

Physical Dimensions inches (millimeters)

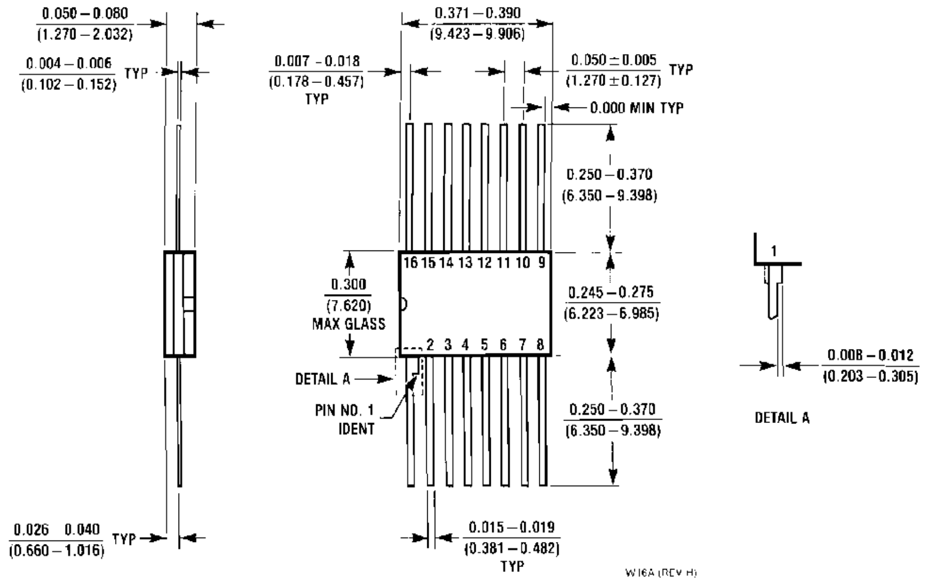


16-Lead Ceramic Dual-In-Line Package (J)
Order Number 9316DMQB or DM9316J
NS Package Number J16A



16-Lead Molded Dual-In-Line Package (N)
Order Number DM9316N
NS Package Number N16E

Physical Dimensions inches (millimeters) (Continued)



16-Lead Ceramic Flat Package (W)
Order Number 9316FMQB or DM9316W
NS Package Number W16A

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